# BLL8H0514L-130; BLL8H0514LS-130 LDMOS driver transistor Rev. 3 — 1 September 2015

**AMPLEON** 

Product data sheet

#### **Product profile**

#### 1.1 General description

130 W LDMOS transistor intended for pulsed applications in the 0.5 GHz to 1.4 GHz range.

**Application information** Table 1.

Typical RF performance at  $T_{\text{case}} = 25 \, ^{\circ}\text{C}$ ;  $I_{\text{Dg}} = 50 \, \text{mA}$ ; in a class-AB application circuit.

| Test signal | f            | tp   | δ   | V <sub>DS</sub> | $P_L$ | Gp   | RLin | $\eta_D$ | P <sub>droop(pulse)</sub> | t <sub>r</sub> | t <sub>f</sub> |
|-------------|--------------|------|-----|-----------------|-------|------|------|----------|---------------------------|----------------|----------------|
|             | (MHz)        | (µs) | (%) | (V)             | (W)   | (dB) | (dB) | (%)      | (dB)                      | (ns)           | (ns)           |
| pulsed RF   | 960 to 1215  | 128  | 10  | 50              | 130   | 19   | 10   | 54       | 0                         | 15             | 8              |
|             | 1200 to 1400 | 300  | 10  | 50              | 130   | 17   | 10   | 50       | 0                         | 15             | 8              |

#### 1.2 Features and benefits

- Easy power control
- Integrated dual side ESD protection
- High flexibility with respect to pulse formats
- Excellent ruggedness
- High efficiency
- Excellent thermal stability
- Designed for broadband operation (0.5 GHz to 1.4 GHz)
- Compliant to Directive 2002/95/EC, regarding Restriction of Hazardous Substances (RoHS)

#### 1.3 Applications

Amplifiers for pulsed applications in the 0.5 GHz to 1.4 GHz frequency range

## 2. Pinning information

Table 2. Pinning

|            | Pagarintian      | Cimendifical cutting | Cuambia avendal                               |
|------------|------------------|----------------------|---|
| Pin        | Description      | Simplified outline   | Graphic symbol                                |
| BLL8H0514L | -130 (SOT1135A)  |                      |   |
| 1          | drain            |                      |   |
| 2          | gate             | 1                    | , <u>, , , , , , , , , , , , , , , , , , </u> |
| 3          | source [1]       | 2                    | 2 — 3<br>sym112                               |
| BLL8H0514L | S-130 (SOT1135B) |                      |   |
| 1          | drain            |                      |   |
| 2          | gate             | 1                    | <u> </u>                                      |
| 3          | source [1]       | 2                    | 2 — 3<br>sym112                               |

<sup>[1]</sup> Connected to flange.

## 3. Ordering information

Table 3. Ordering information

| Type number     | Packag                                     | Package  |          |  |  |  |
|-----------------|--|--|----------|--|--|--|
|                 | Name                                       | Name Description                                   |          |  |  |  |
| BLL8H0514L-130  | -  | flanged ceramic package; 2 mounting holes; 2 leads | SOT1135A |  |  |  |
| BLL8H0514LS-130 | - earless flanged ceramic package; 2 leads |  | SOT1135B |  |  |  |

## 4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol           | Parameter            | Conditions | Min | Max  | Unit |
|------------------|----------------------|------------|-----|------|------|
| $V_{DS}$         | drain-source voltage |            | -   | 100  | V    |
| $V_{GS}$         | gate-source voltage  |            | -6  | +13  | V    |
| T <sub>stg</sub> | storage temperature  |            | -65 | +150 | °C   |
| Tj               | junction temperature | [1]        | -   | 225  | °C   |

<sup>[1]</sup> Continuous use at maximum temperature will affect the reliability, for details refer to the on-line MTF calculator.

#### 5. Thermal characteristics

Table 5. Thermal characteristics

| Symbol           | Parameter                               | Conditions  | Тур  | Unit |
|------------------|---|---|------|------|
|                  |   | T <sub>case</sub> = 85 °C; P <sub>L</sub> = 130 W |      |      |
| junction to case | $t_p = 100 \ \mu s; \ \delta = 10 \ \%$ | 0.17  | K/W  |      |
|                  | $t_p = 200 \ \mu s; \ \delta = 10 \ \%$ | 0.22  | K/W  |      |
|                  | $t_p = 300 \ \mu s; \ \delta = 10 \ \%$ | 0.25  | K/W  |      |
|                  | t <sub>p</sub> = 100 μs; δ = 20 %       | 0.23  | K/W  |      |
|                  |   | $t_p$ = 1 ms; $\delta$ = 10 %                     | 0.36 | K/W  |

### 6. Characteristics

Table 6. DC characteristics

 $T_i = 25$  °C; per section unless otherwise specified.

| Symbol               | Parameter                        | Conditions  | Min  | Тур | Max  | Unit |
|----------------------|----------------------------------|---|------|-----|------|------|
| V <sub>(BR)DSS</sub> | drain-source breakdown voltage   | $V_{GS} = 0 \text{ V}; I_D = 630 \text{ mA}$              | 100  | -   | -    | V    |
| V <sub>GS(th)</sub>  | gate-source threshold voltage    | V <sub>DS</sub> = 10 V; I <sub>D</sub> = 135 mA           | 1.3  | 1.8 | 2.25 | V    |
| I <sub>DSS</sub>     | drain leakage current            | V <sub>GS</sub> = 0 V; V <sub>DS</sub> = 50 V             | -    | -   | 1.4  | μΑ   |
| I <sub>DSX</sub>     | drain cut-off current            | $V_{GS} = V_{GS(th)} + 3.75 V;$<br>$V_{DS} = 10 V$        | 15.8 | 18  | -    | Α    |
| I <sub>GSS</sub>     | gate leakage current             | V <sub>GS</sub> = 11 V; V <sub>DS</sub> = 0 V             | -    | -   | 140  | nA   |
| g <sub>fs</sub>      | forward transconductance         | V <sub>DS</sub> = 10 V; I <sub>D</sub> = 135 mA           | 806  | -   | 1578 | mS   |
| R <sub>DS(on)</sub>  | drain-source on-state resistance | $V_{GS} = V_{GS(th)} + 6.25 V;$<br>$I_D = 135 \text{ mA}$ | -    | 200 | 275  | mΩ   |

#### Table 7. RF characteristics

Test signal: pulsed RF;  $t_p$  = 300  $\mu$ s;  $\delta$  = 10 %; RF performance at  $V_{DS}$  = 50 V;  $I_{Dq}$  = 50 mA; f = 1.2 GHz to 1.4 GHz;  $T_{case}$  = 25 °C; unless otherwise specified, in a class-AB production test circuit.

| Symbol                    | Parameter            | Conditions             | Min | Тур | Max | Unit |
|---------------------------|----------------------|------------------------|-----|-----|-----|------|
| $V_{DS}$                  | drain-source voltage | P <sub>L</sub> = 130 W | -   | -   | 50  | V    |
| G <sub>p</sub>            | power gain           | P <sub>L</sub> = 130 W | 15  | 17  | -   | dB   |
| RLin                      | input return loss    | P <sub>L</sub> = 130 W | -   | -10 | -7  | dB   |
| $\eta_{D}$                | drain efficiency     | P <sub>L</sub> = 130 W | 45  | 50  | -   | %    |
| P <sub>droop(pulse)</sub> | pulse droop power    | P <sub>L</sub> = 130 W | -   | 0   | 0.3 | dB   |
| t <sub>r</sub>            | rise time            | P <sub>L</sub> = 130 W | -   | 20  | 50  | ns   |
| t <sub>f</sub>            | fall time            | P <sub>L</sub> = 130 W | -   | 6   | 50  | ns   |

## 7. Application information

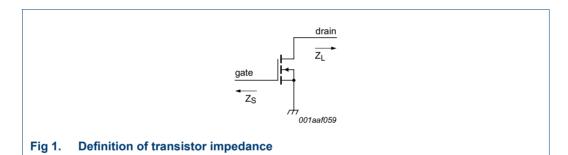
#### 7.1 Ruggedness in class-AB operation

The BLL8H0514L-130 and BLL8H0514LS-130 are capable of withstanding a load mismatch corresponding to VSWR = 5 : 1 through all phases under the following conditions:  $V_{DS}$  = 50 V;  $I_{Dq}$  = 50 mA;  $P_L$  = 130 W; f = 1.2 GHz to 1.4 GHz;  $t_p$  = 300  $\mu$ s;  $\delta$  = 10 %.

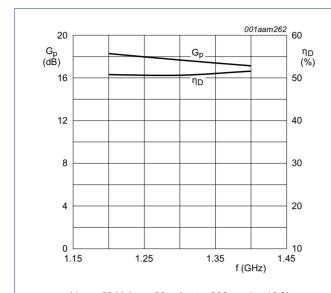
#### 7.2 Impedance information

Table 8. Typical impedance

| f     | Z <sub>S</sub> | Z <sub>L</sub> |
|-------|----------------|----------------|
| (MHz) | (Ω)            | (Ω)            |
| 1200  | 1.21 – j3.44   | 2.40 – j0.63   |
| 1300  | 1.56 – j4.49   | 2.30 – j0.87   |
| 1400  | 2.21 – j4.86   | 2.00 – j1.71   |

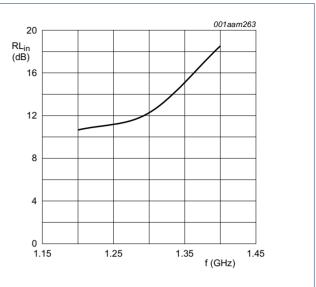


#### 7.3 Performance curves



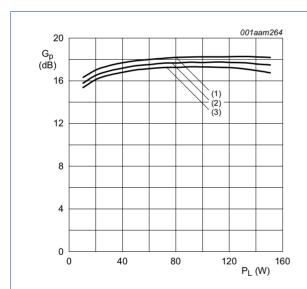
 $V_{DS}$  = 50 V;  $I_{Dq}$  = 50 mA;  $t_p$  = 300  $\mu s;$   $\delta$  = 10 %.

Fig 2. Power gain and drain efficiency as function of frequency; typical values



 $V_{DS}$  = 50 V;  $I_{Dq}$  = 50 mA;  $t_p$  = 300  $\mu$ s;  $\delta$  = 10 %.

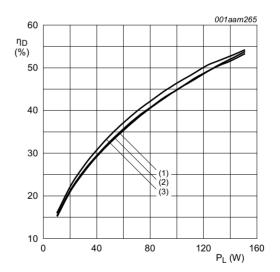
Fig 3. Input return loss as a function of frequency; typical values



 $V_{DS}$  = 50 V;  $I_{Dq}$  = 50 mA;  $t_p$  = 300  $\mu s;$   $\delta$  = 10 %.

- (1) f = 1.2 GHz
- (2) f = 1.3 GHz
- (3) f = 1.4 GHz

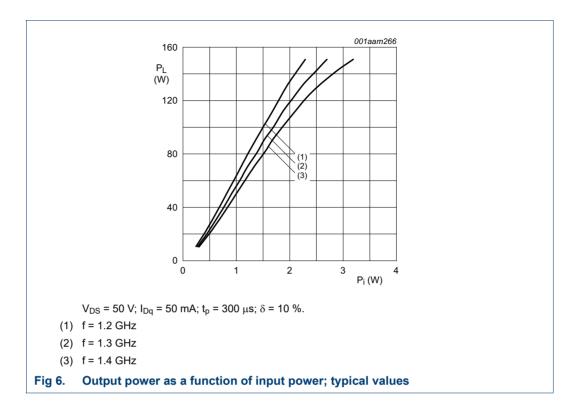
Fig 4. Power gain as a function of output power; typical values



 $V_{DS}$  = 50 V;  $I_{Dq}$  = 50 mA;  $t_p$  = 300  $\mu$ s;  $\delta$  = 10 %.

- (1) f = 1.2 GHz
- (2) f = 1.3 GHz
- (3) f = 1.4 GHz

Fig 5. Drain efficiency as a function of output power; typical values



#### 8. Test information

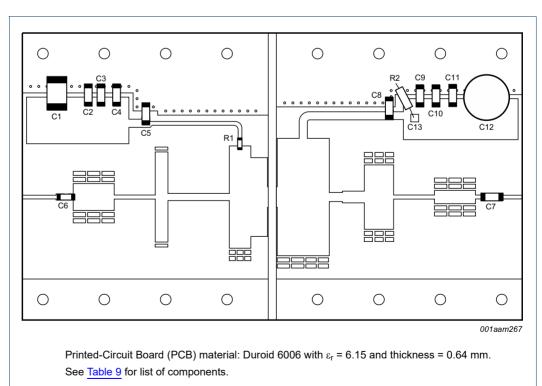


Fig 7. Component layout

**Table 9. List of components** See *Figure 7* for component layout.

| Component           | Description                            | Value          | Remarks                             |
|---------------------|--|----------------|-------------------------------------|
| C1                  | multilayer ceramic chip capacitor      | 10 μF, 50 V    |                                     |
| C2, C11             | multilayer ceramic chip capacitor 1 nF |                |                                     |
| C3, C4, C6, C9, C10 | multilayer ceramic chip capacitor      | 100 pF [2]     |                                     |
| C5, C7, C8          | multilayer ceramic chip capacitor      | 43 pF [2]      |                                     |
| C12                 | electrolytic capacitor                 | 220 μF, 63 V   |                                     |
| C13                 | multilayer ceramic chip capacitor      | 1 nF [3]       | fitted vertically in series with R2 |
| R1                  | SMD resistor                           | 10 Ω           | SMD 0603                            |
| R2                  | wirewound lead resistor                | 2.61 Ω, 0.25 W | fitted in series<br>with C13        |

- [1] American Technical Ceramics type 700A or capacitor of same quality.
- [2] American Technical Ceramics type 100A or capacitor of same quality.
- [3] American Technical Ceramics type 100B or capacitor of same quality.

### 9. Package outline

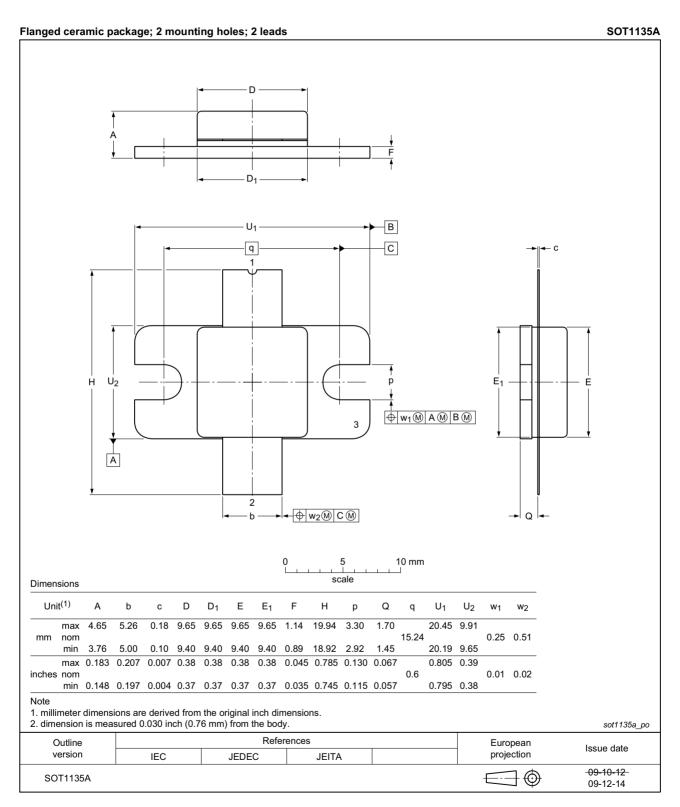


Fig 8. Package outline SOT1135A

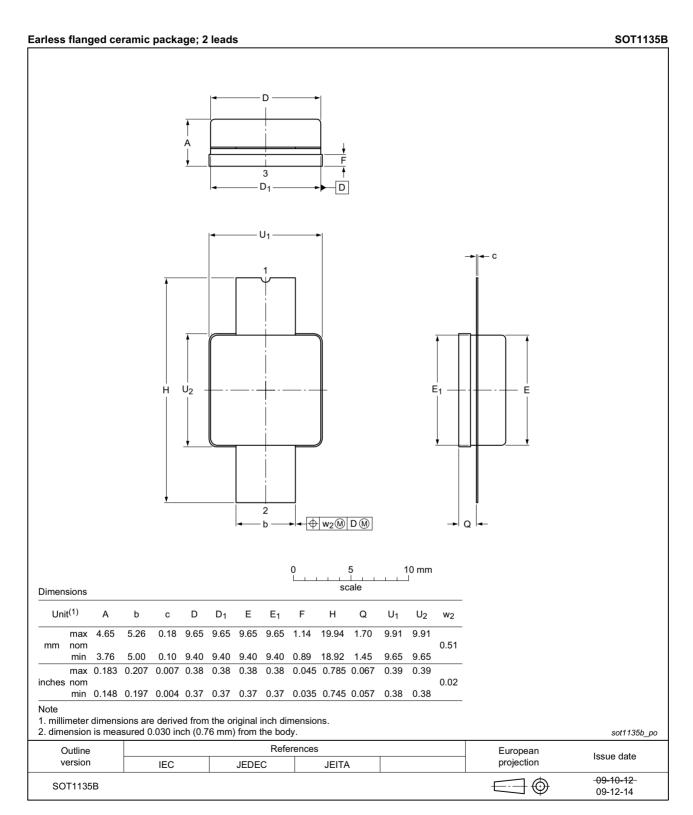


Fig 9. Package outline SOT1135B

## 10. Handling information

#### CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.

Such precautions are described in the ANSI/ESD S20.20, IEC/ST 61340-5, JESD625-A or equivalent standards.

## 11. Abbreviations

Table 10. Abbreviations

| Acronym | Description                                |  |
|---------|--|--|
| ESD     | ctroStatic Discharge                       |  |
| LDMOS   | terally Diffused Metal-Oxide Semiconductor |  |
| MTF     | Median Time to Failure                     |  |
| SMD     | Surface Mounted Device                     |  |
| VSWR    | Voltage Standing-Wave Ratio                |  |

## 12. Revision history

Table 11. Revision history

| Document ID                 | Release date   | Data sheet status    | Change notice | Supersedes                      |  |
|-----------------------------|--|----------------------|---------------|---------------------------------|--|
| BLL8H0514L-130_0514LS-130#3 | 20150901   | Product data sheet   | -             | BLL8H0514L-130_0514LS-130<br>#2 |  |
| Modifications:              | <ul> <li>The format of this document has been redesigned to comply with the new identity guidelines of Ampleon.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> </ul> |                      |               |                                 |  |
| BLL8H0514L-130_0514LS-130#2 | 20150209   | Product data sheet   | -             | BLL8H0514L-130_0514LS-130<br>#1 |  |
| BLL8H0514L-130_0514LS-130#1 | 20140930   | Objective data sheet | -             | -                               |  |

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#### 13.1 Data sheet status

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|--|-------------------|---|
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| Preliminary [short] data sheet Qualification |                   | This document contains data from the preliminary specification.                       |
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## BLL8H0514L(S)-130

**LDMOS** driver transistor

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## BLL8H0514L(S)-130

**LDMOS** driver transistor

#### 15. Contents

| 1    | Product profile                  | . 1 |
|------|----------------------------------|-----|
| 1.1  | General description              | . 1 |
| 1.2  | Features and benefits            |     |
| 1.3  | Applications                     |     |
| 2    | Pinning information              | . 2 |
| 3    | Ordering information             | . 2 |
| 4    | Limiting values                  |     |
| 5    | Thermal characteristics          |     |
| 6    | Characteristics                  |     |
| 7    | Application information          |     |
| 7.1  | Ruggedness in class-AB operation |     |
| 7.2  | Impedance information            |     |
| 7.3  | Performance curves               | . 5 |
| 8    | Test information                 | . 6 |
| 9    | Package outline                  | . 8 |
| 10   | Handling information             | 10  |
| 11   | Abbreviations                    | 10  |
| 12   | Revision history                 | 10  |
| 13   | Legal information                | 11  |
| 13.1 | Data sheet status                | 11  |
| 13.2 | Definitions                      | 11  |
| 13.3 | Disclaimers                      | 11  |
| 13.4 | Trademarks                       | 12  |
| 14   | Contact information              | 12  |
| 15   | Contents                         | 12  |

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